

Optical Interconnection Design Innovator

400GbE to 4x100GbE (QSFP56-DD to 4xQSFP56) MMF Active Optical Splitter Cable P/N: GDA4-MDO401-XXXCA

Features

- ✓ Hot-plug QSFP56-DD and QSFP56 form factor
- √ 8x 50Gb/s PAM4 modulation
- ✓ Low power dissipation <9W (400G End)
- ✓ Low power dissipation <4.5W (100G End)</p>
- ✓ RoHS-6 compliant (lead-free)
- ✓ Commercial case temperature range of 0°C to 70°C
- ✓ Single 3.3V power supply
- ✓ Maximum link length of 70m on OM3 MMF
 and 100m on OM4 & OM5 MMF
- ✓ Uncooled 850nm VCSEL array (both End)
- ✓ PIN photo detector array (both End)
- √ 400GBASE-SR8 and 100GBASE-SR2 compliant
- ✓ I2C management interface
- ✓ CMIS V4.0 compliant

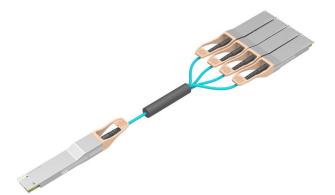
Applications

- ✓ IEEE 802.3cd 100GBASE-SR2 Ethernet (PAM4)
- ✓ IEEE 802.3cd 400GBASE-SR8 Ethernet (PAM4)

Description

Gigalight's GDA4-MDO401-XXXCA MMF Active Optical Splitter Cable is used in 4 X 100 Gigabit Ethernet links over OM3/OM4/OM5 multimode fiber, which provides connectivity between system units with a 400GbE connector on one side and four separate 100GbE connectors on the other four sides. The cable connects data signals from each of the 8 MMF (Multi Mode Fiber) pairs on the single QSFP56-DD end to the dual pair of each of the QSFP56 multiport ends.

Gigalight's GDA4-MDO401-XXXCA MMF Active Optical Splitter Cable is compliant with the QSFP-DD-MSA and with 100GBASE-SR2 specification. Digital diagnostics functions are available via the I2C interface as specified by CMIS V4.0. The transceiver is RoHS 2.0 compliant and lead-free per Directive 2011/65/EU.



Optical Interconnection Design Innovator

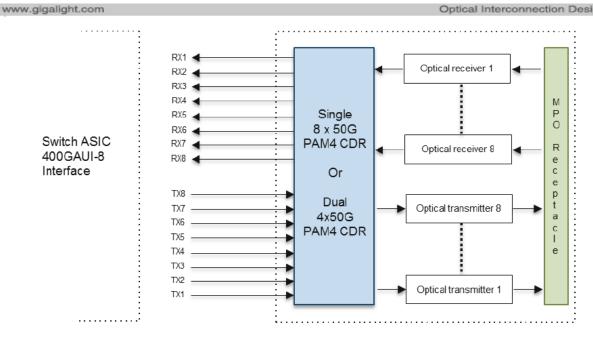


Figure 1. Module Block Diagram (400G End)

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V _{cc}	-0.3	3.6	V
Input Voltage	V_{in}	-0.3	V _{cc} +0.3	V
Storage Temperature	Ts	-20	85	°C
Case Operating Temperature	T _c	0	70	°C
Humidity (non-condensing)	Rh	5	95	%

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage	V _{cc}	3.13	3.3	3.47	V
Operating Case Temperature	T _c	0		70	°C
Baud Rate per Lane (PAM4)	fd		26.5625		GBaud/s
Humidity	Rh	5		85	%
Power Dissipation	P_{m}			9.0	W
Fiber Bend Radius	R _b	3			cm

Electrical Specifications

Parameter	Symbol	Min	Typical	Max	Unit
Differential Input Impedance	Z _{in}	90	100	110	ohm
Differential Output Impedance	Z _{out}	90	100	110	ohm
Differential Input Voltage Amplitude	ΔV_{in}	300		900	mVppd
Differential Output Voltage Amplitude	ΔV_{out}	300		900	mVppd
Bit Error Rate Note2	BER			2.4E-4	
Input Logic Level High	V _{IH}	2.0		Vcc	V



深圳市易飞扬通信技术有限公司 Shenzhen Gigalight Technology Co., Ltd.

www.gigalight.com		Ol	ptical Interconne	ction Design I	nnovator
Input Logic Level Low	VIL	0		0.8	V
Output Logic Level High	V _{OH}	V _{cc} -0.5		V_{cc}	V
Output Logic Level Low	V _{OL}	0		0.4	V

Note:

Note2. Pre-FEC BER, compliant with 400GBASE-SR8 specification.

Optical Characteristics

Parameter	Symbol	Min	Typical	Max	Unit
Transmitter					
Center Wavelength	λс	840	850	860	nm
RMS Spectral Width	Δλ			0.6	nm
Average Launch Power (each lane)	P _{out}	-6		6	dBm
Outer Optical Modulation Amplitude (each lane)	OMA _{out}	-4		5	dBm
Launch power in OMA _{outer} minus TDECQ	P _{tdecq}	-5.9			dBm
Transmitter and dispersion eye closure (each lane)	TDECQ			4.9	dB
Average launch power of off transmitter(each lane)	Poff			-30	dBm
Outer Extinction Ratio	ER	3			dB
Optical Return Loss Tolerance	ORLT			12	dB
Re	ceiver				
Center Wavelength	λ _c	840	850	860	nm
Damage threshold	Rdam	6			dBm
Average Receive Power (each lane)	Pin	-7.9		4	dBm
Receiver Power (OMA _{outer}) (each lane)	OMA _{out}			3	dBm
Receiver reflectance	Pref			-12	dB
Stressed Sensitivity (OMA _{outer}) (each lane) Note3	Sens			-3	dBm
Receiver Sensitivity (OMA _{outer}) (each lane) Note4	Seno			-7	dB

Note:

Note3. Measured with conformance test signal at TP3 for the BER specified in IEEE 802.3cd.

Note4. Measured with conformance test signal at TP3 for the BER specified in IEEE 802.3cd.

Pin Description

Pin	Logic	Symbol	Name/Description	
1		GND	Module Ground ^{Note5}	
2	CML-I	Tx2-	Transmitter inverted data input	
3	CML-I	Tx2+	Transmitter non-inverted data input	
4		GND	Module Ground Note5	
5	CML-I	Tx4-	Transmitter inverted data input	
6	CML-I	Tx4+	Transmitter non-inverted data input	
7		GND	Module Ground ^{Note5}	
8	LVTTL-I	MODSEIL	Module Select ^{Note6}	
9	LVTTL-I	ResetL	Module Reset ^{Note6}	
10		VCCRx	+3.3V Power Supply	



深圳市易飞扬通信技术有限公司 Shenzhen Gigalight Technology Co., Ltd.

Optical Interconnection Design Innovator

11	ww	w.gigalight.com		Optical Interconnection Design Innovator	
12	11	LVCMOS-I	SCL	2-wire Serial interface clock ^{Note6}	
GND	12	LVCMOS-I/O	SDA		
15 CML-O RX3- Receiver inverted data output 16 GND Module Ground** 17 CML-O RX1+ Receiver non-inverted data output 18 CML-O RX1- Receiver inverted data output 19 GND Module Ground** 20 GND Module Ground** 21 CML-O RX2- Receiver inverted data output 22 CML-O RX2- Receiver inverted data output 23 GND Module Ground** 24 CML-O RX4- Receiver non-inverted data output 25 CML-O RX4- Receiver non-inverted data output 26 GND Module Ground** 27 LVTTL-O ModPrsL Module Ground** 28 LVTTL-O ModPrsL Module Ground** 30 VCC1 +3.3V Transmitter Power Supply 31 LVTTL-I LPMode Low Power Mode** 32 GND Module Ground** 33 CML-I Tx3+ Transmitter inverted data input 34 CML-I Tx3+ Transmitter inon-inverted data input 37 CML-I Tx1+ Transmitter inon-inverted data input 38 GND Module Ground** 39 GND Module Ground** 30 CML-I Tx1+ Transmitter inon-inverted data input 31 CML-I Tx3+ Transmitter inverted data input 32 GND Module Ground** 33 CML-I Tx3+ Transmitter inverted data input 34 CML-I Tx3+ Transmitter inverted data input 36 GND Module Ground** 37 CML-I Tx1+ Transmitter inverted data input 38 GND Module Ground** 39 GND Module Ground** 30 GND Module Ground** 31 CML-I Tx6- Transmitter inverted data input 42 GNL-I Tx6- Transmitter inverted data input 44 CML-I Tx6- Transmitter inverted data input 45 GND Module Ground** 46 Reserved 47 Transmitter inverted data input 48 CML-I Tx8- Transmitter inverted data input 49 GND Module Ground** 49 TBD For future use 49 TBD For future use 50 GND Module Ground** 50 GND Module Ground** 51 GND Module Ground** 52 CML-O RX7- Receiver non-inverted data output 53 CML-O RX7- Receiver non-inverted data output 54 CML-O RX5- Receiver inverted data output 55 CML-O RX5- Receiver inverted data output	13		GND		
16	14	CML-O	RX3+	Receiver non-inverted data output	
17	15	CML-O	RX3-	Receiver inverted data output	
18	16		GND	Module Ground ^{Note5}	
19	17	CML-O	RX1+	Receiver non-inverted data output	
20	18	CML-O	RX1-	Receiver inverted data output	
20	19		GND	Module Ground ^{Note5}	
CML-O	20		GND		
CML-O	21	CML-O	RX2-	Receiver inverted data output	
24 CML-O RX4+ Receiver inverted data output 25 CML-O RX4+ Receiver non-inverted data output 26 GND Module Ground ^{Noxes} 27 LVTTL-O ModPrsL Module Present, internal pulled down to GND 28 LVTTL-O IntL Interrupt output, should be pulled up on host board ² 29 VCCTX +3.3V Transmitter Power Supply 30 VCC1 +3.3V Power Supply 31 LVTTL-I LPMode Low Power Mode Notes 32 GND Module Ground*Notes 33 CML-I TX3+ Transmitter non-inverted data input 34 CML-I TX3+ Transmitter inverted data input 35 GND Module Ground*Notes 36 CML-I TX1+ Transmitter inverted data input 37 CML-I TX1+ Transmitter inverted data input 38 GND Module Ground*Notes 40 CML-I TX6- Transmitter inverted data input 41 CML-I TX6-	22	CML-O	RX2+	·	
25 CML-O RX4+ Receiver non-inverted data output 26 GND Module Ground ^{Noves} 27 LVTTL-O ModPrsL Module Present, internal pulled down to GND 28 LVTTL-O IntL Interrupt output, should be pulled up on host board² 29 VCCTx +3.3V Transmitter Power Supply 30 VCC1 +3.3V Power Supply 31 LVTTL-I LPMode Low Power ModeNotes 32 GND Module GroundNotes 33 CML-I Tx3+ Transmitter non-inverted data input 34 CML-I Tx3+ Transmitter inverted data input 35 GND Module GroundNotes 36 CML-I Tx1+ Transmitter inverted data input 37 CML-I Tx1- Transmitter inverted data input 38 GND Module GroundNotes 40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6- Transmitter inverted data input 42 GND Module GroundNotes <td>23</td> <td></td> <td>GND</td> <td>Module Ground^{Note5}</td>	23		GND	Module Ground ^{Note5}	
26	24	CML-O	RX4-	Receiver inverted data output	
27	25	CML-O	RX4+	Receiver non-inverted data output	
28 LVTTL-O Intl. Interrupt output, should be pulled up on host board² 29 VCCTx +3.3V Transmitter Power Supply 30 VCC1 +3.3V Power Supply 31 LVTTL-I LPMode Low Power Mode Note6 32 GND Module Ground*Note5 33 CML-I Tx3+ Transmitter non-inverted data input 34 CML-I Tx3- Transmitter inverted data input 35 GND Module Ground*Note5 36 CML-I Tx1+ Transmitter non-inverted data input 37 CML-I Tx1+ Transmitter inverted data input 38 GND Module Ground*Note5 39 GND Module Ground*Note5 40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6- Transmitter inverted data input 42 GND Module Ground*Note5 43 CML-I Tx8- Transmitter non-inverted data input 44 CML-I Tx8- Transmitter non-inverted data input 45 GND Module Ground*Note5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module Ground*Note5 52 CML-O RX7+ Receiver inverted data output 55 CML-O RX5- Receiver inverted data output 56 CML-O RX5- Receiver inverted data output	26		GND	Module Ground ^{Note5}	
VCCTx	27	LVTTL-O	ModPrsL	Module Present, internal pulled down to GND	
VCCTx	28	LVTTL-O	IntL	Interrupt output, should be pulled up on host board ²	
Section Sect	29		VCCTx		
GND Module Ground Module	30		VCC1	+3.3V Power Supply	
33 CML-I Tx3+ Transmitter non-inverted data input 34 CML-I Tx3- Transmitter inverted data input 35 GND Module GroundNote5 36 CML-I Tx1+ Transmitter non-inverted data input 37 CML-I Tx1- Transmitter inverted data input 38 GND Module GroundNote5 40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6+ Transmitter inverted data input 41 CML-I Tx8+ Transmitter inverted data input 42 GND Module Ground Note5 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module GroundNote5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 51 GND Module GroundNote5	31	LVTTL-I	LPMode	Low Power Mode ^{Note6}	
34 CML-I 35 GND Module Ground Notes 36 CML-I 37 CML-I 38 GND Module Ground Notes 39 GND Module Ground Notes 40 CML-I 41 Tx6- 41 Tx6- 42 GND Module Ground Notes 43 CML-I 44 CML-I 45 GND Module Ground Notes 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module Ground Notes 52 CML-O RX7- 54 GND Module Ground Notes 53 CML-O RX5- 55 CML-O RX5- 56 CML-O RX5- 56 CML-O RX5- 56 CML-O RX5- 57 TRAS Transmitter inverted data input 57 Transmitter inverted data input 58 Transmitter non-inverted data input 58 Transmitter non-inverted data input 59 Transmitter inverted data input 50 TBD For future use 50 TBD For future use 50 TBD For future use	32		GND	Module Ground ^{Note5}	
GND Module Ground Notes	33	CML-I	Tx3+	Transmitter non-inverted data input	
Tx1+ Transmitter non-inverted data input	34	CML-I	Tx3-	Transmitter inverted data input	
37 CML-I 38 GND Module Ground Mote5 39 GND Module Ground Mote5 40 CML-I 41 CML-I 42 GND Module Ground Mote5 43 CML-I 44 CML-I 45 GND Module Ground Mote5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD Module Ground Mote5 51 GND Module Ground Mote5 52 CML-O RX7+ Receiver inverted data output 54 GND Module Ground Mote5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5+ Receiver inverted data output 57 Receiver inverted data output 58 GND Module Ground Mote5 59 CML-O RX5+ Receiver non-inverted data output 50 RS5- Receiver inverted data output 51 GND Module Ground Mote5 52 CML-O RX7- Receiver inverted data output 53 CML-O RX5- Receiver non-inverted data output	35		GND	Module Ground ^{Note5}	
38 GND Module GroundNotes 39 GND Module GroundNotes 40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6+ Transmitter non-inverted data input 42 GND Module Ground Notes 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module GroundNotes 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module GroundNotes 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module GroundNotes 55 CML-O RX5+ Receiver non-inverted data output	36	CML-I	Tx1+	Transmitter non-inverted data input	
39 GND Module GroundNote5 40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6+ Transmitter non-inverted data input 42 GND Module Ground Note5 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module GroundNote5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module GroundNote5 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module GroundNote5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	37	CML-I	Tx1-	Transmitter inverted data input	
40 CML-I Tx6- Transmitter inverted data input 41 CML-I Tx6+ Transmitter non-inverted data input 42 GND Module Ground Note5 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module Ground Note5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module Ground Note5 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module Ground Note5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	38		GND	Module Ground ^{Note5}	
41 CML-I Tx6+ Transmitter non-inverted data input 42 GND Module Ground Note5 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module Ground Note5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module Ground Note5 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module Ground Note5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	39		GND	Module Ground ^{Note5}	
GND Module Ground Note5 43 CML-I Tx8- Transmitter inverted data input 44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module Ground Note5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module Ground Note5 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module Ground Rote5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	40	CML-I	Tx6-	Transmitter inverted data input	
CML-I Tx8- Transmitter inverted data input CML-I Tx8+ Transmitter non-inverted data input GND Module GroundNote5 Reserved TBD For future use VCC +3.3V Receiver Power Supply TBD For future use TBD For future use TBD For future use TBD For future use CML-O RX7+ Receiver non-inverted data output GND Module GroundNote5 CML-O RX7- Receiver inverted data output CML-O RX5+ Receiver non-inverted data output RX5- Receiver non-inverted data output RX5- Receiver inverted data output RX5- Receiver inverted data output	41	CML-I	Tx6+	Transmitter non-inverted data input	
44 CML-I Tx8+ Transmitter non-inverted data input 45 GND Module GroundNote5 46 Reserved 47 TBD For future use 48 VCC +3.3V Receiver Power Supply 49 TBD For future use 50 TBD For future use 51 GND Module GroundNote5 52 CML-O RX7+ Receiver non-inverted data output 53 CML-O RX7- Receiver inverted data output 54 GND Module GroundNote5 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	42		GND	Module Ground Note5	
GND Module Ground Note5 Reserved TBD For future use 48 VCC +3.3V Receiver Power Supply TBD For future use TBD For future	43	CML-I	Tx8-	Transmitter inverted data input	
46Reserved47TBDFor future use48VCC+3.3V Receiver Power Supply49TBDFor future use50TBDFor future use51GNDModule GroundNote552CML-ORX7+Receiver non-inverted data output53CML-ORX7-Receiver inverted data output54GNDModule GroundNote555CML-ORX5+Receiver non-inverted data output56CML-ORX5-Receiver inverted data output	44	CML-I	Tx8+		
TBD For future use VCC +3.3V Receiver Power Supply TBD For future use CML-O RX7+ Receiver non-inverted data output CML-O RX7- Receiver inverted data output CML-O RX5+ Receiver non-inverted data output RX5- Receiver non-inverted data output RX5- Receiver inverted data output	45		GND	Module Ground ^{Note5}	
48VCC+3.3V Receiver Power Supply49TBDFor future use50TBDFor future use51GNDModule GroundNote552CML-ORX7+Receiver non-inverted data output53CML-ORX7-Receiver inverted data output54GNDModule GroundNote555CML-ORX5+Receiver non-inverted data output56CML-ORX5-Receiver inverted data output	46		Reserved		
TBD For future use TBD Fo	47		TBD	For future use	
TBD For future use GND Module Ground ^{Note5} CML-O RX7+ Receiver non-inverted data output CML-O RX7- Receiver inverted data output GND Module Ground ^{Note5} CML-O RX5+ Receiver non-inverted data output CML-O RX5+ Receiver non-inverted data output RX5- Receiver inverted data output	48		VCC	+3.3V Receiver Power Supply	
51GNDModule GroundNote552CML-ORX7+Receiver non-inverted data output53CML-ORX7-Receiver inverted data output54GNDModule GroundNote555CML-ORX5+Receiver non-inverted data output56CML-ORX5-Receiver inverted data output	49		TBD	For future use	
52CML-ORX7+Receiver non-inverted data output53CML-ORX7-Receiver inverted data output54GNDModule GroundNote555CML-ORX5+Receiver non-inverted data output56CML-ORX5-Receiver inverted data output	50		TBD	For future use	
53 CML-O RX7- Receiver inverted data output 54 GND Module Ground ^{Note5} 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	51		GND	Module Ground ^{Note5}	
54 GND Module Ground ^{Note5} 55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	52	CML-O	RX7+	Receiver non-inverted data output	
55 CML-O RX5+ Receiver non-inverted data output 56 CML-O RX5- Receiver inverted data output	53	CML-O	RX7-	Receiver inverted data output	
56 CML-O RX5- Receiver inverted data output	54		GND	Module Ground ^{Note5}	
· · · · · · · · · · · · · · · · · · ·	55	CML-O	RX5+	Receiver non-inverted data output	
57 GND Module Ground ^{Note5}	56	CML-O	RX5-	Receiver inverted data output	
	57		GND	Module Ground ^{Note5}	



ww	w.gigalight.com		Optical Interconnection Design Innovator
58		GND	Module Ground ^{Note5}
59	CML-O	RX6-	Receiver inverted data output
60	CML-O	RX6+	Receiver non-inverted data output
61		GND	Module Ground ^{Note5}
62	CML-O	RX8-	Receiver inverted data output
63	CML-O	RX8+	Receiver non-inverted data output
64		GND	Module Ground ^{Note5}
65		NC	No connect
66		TBD	For future use
67		VCC	+3.3V Power Supply
68		VCC	+3.3V Power Supply
69		TBD	For future use
70		GND	Module Ground ^{Note5}
71	CML-I	Tx7+	Transmitter non-inverted data input
72	CML-I	Tx7-	Transmitter inverted data input
73		GND	Module Ground ^{Note5}
74	CML-I	Tx5+	Transmitter non-inverted data input
75	CML-I	Tx5-	Transmitter inverted data input
76		GND	Module Ground ^{Note5}

Note:

Note5. Module circuit ground is isolated from module chassis ground within the module.

Note6. Open collector should be pulled up with 4.7K to 10K ohms on host board to a voltage between 3.15V and 3.6V.

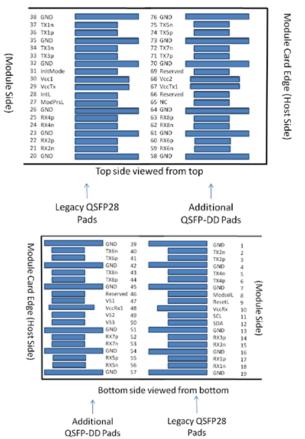


Figure 2. Electrical Pin-out Details



ModSelL Pin

The ModSelL is an input pin. When held low by the host, the module responds to 2-wire serial communication commands. The ModSelL allows the use of multiple QSFP modules on a single 2-wire interface bus. When the ModSelL is "High", the module will not respond to any 2-wire interface communication from the host. ModSelL has an internal pull-up in the module.

ResetL Pin

Reset. LPMode_Reset has an internal pull-up in the module. A low level on the ResetL pin for longer than the minimum pulse length (t_Reset_init) initiates a complete module reset, returning all user module settings to their default state. Module Reset Assert Time (t_init) starts on the rising edge after the low level on the ResetL pin is released. During the execution of a reset (t_init) the host shall disregard all status bits until the module indicates a completion of the reset interrupt. The module indicates this by posting an IntL signal with the Data_Not_Ready bit negated. Note that on power up (including hot insertion) the module will post this completion of reset interrupt without requiring a reset.

LPMode Pin

Gigalight QSFP28 modules operate in the low power mode (less than 1.5 W power consumption). This pin active high will decrease power consumption to less than 1W.

ModPrsL Pin

ModPrsL is pulled up to Vcc on the host board and grounded in the module. The ModPrsL is asserted "Low" when the module is inserted and deasserted "High" when the module is physically absent from the host connector.

IntL Pin

IntL is an output pin. When "Low", it indicates a possible module operational fault or a status critical to the host system. The host identifies the source of the interrupt by using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled up to Vcc on the host board.

Power Supply Filtering

The host board should use the power supply filtering shown in Figure 3.

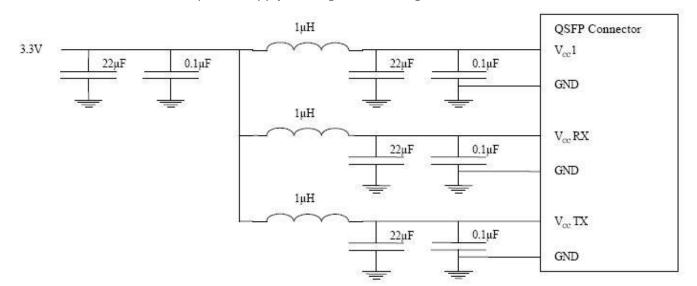


Figure 3. Host Board Power Supply Filtering



DIAGNOSTIC MONITORING INTERFACE

Digital diagnostics functions are available via the I2C interface as specified by CMIS V4.0. The CMIS management memory is shown in **Figure 4**.

Due to eight-bit addresses, the management memory is divided in **Lower Memory** (addresses 00h through 7Fh) and **Upper Memory** (addresses 80h ~ FFh).

The addressing structure of the additional internal management memory is shown in **Figure 5**. The management memory is arranged as a unique and always host accessible address space of 128 bytes (Lower Memory) and as multiple upper address subspaces of 128 bytes each (**Pages**), only one of which is selected as host visible in Upper Memory. A second level of Page selection is possible for Pages for which several instances exist (e.g. where a **bank** of pages with the same Page number exists).

This structure supports a flat 256 byte memory for passive copper modules and permits timely access to addresses in the Lower Memory (e.g. Flags and Monitors). Less time critical entries, e.g. serial ID information and threshold settings, are available with the Page Select function in the Lower Page.

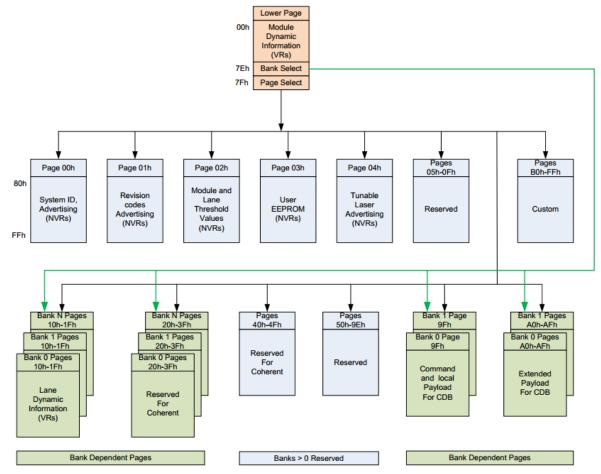


Figure 4. CMIS Bank Page Memory Map

The CMIS memory structure also provides address expansion by adding additional upper pages as needed. Upper pages 00-02 all contain static, non-volatile advertising registers. Upper page 01 provides revision codes and advertising registers that indicate the capabilities of the module. Upper page 02 provides thresholds for monitored functions. Upper page 03 provides a user read/write space.

Optical Interconnection Design Innovator

The lower page, upper pages 00h-03h and bank 0 page 10h-11h are supported in our module.

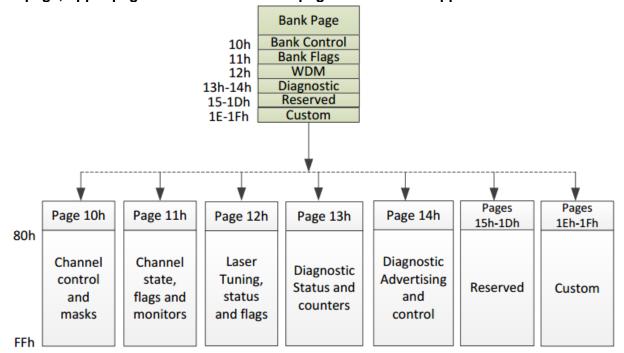


Figure 5. Additional Supported Bank Page Memory Map

The Lower Memory - Page 00h

The Lower Memory consists of the lower 128 bytes of the 256 byte two-wire serial bus addressable space. The Lower Page is used to access a variety of module level measurements, diagnostic functions and control functions, as well as to select which of the various Upper Pages in the structured memory map are accessed by byte addresses greater or equal than 128.

Address	Size	Subject Area	Description
0–3	4	ID and Status Area	Module ID from SFF-8024 list, version number, Type
			and status
			Flat mem indication, CLEI present indicator, Maximum
			TWI speed, Current state of Module, Current state of
			the Interrupt signal
4–7	4	Lane Flag Summary	Flag summary of all lane flags on pages 10h-1Fh
8-13	6	Module-Level Flags	All flags that are not lane or data path specific
14-25	12	Module-Level Monitors	Monitors that are not lane or data path specific
26-30	5	Module Global Controls	Controls applicable to the module as a whole
31-36	6	Module-Level Flag Masks	Masking bits for the Module-Level flags
37-38	2	CDB Status Area	Status of most recent CDB command
39-40	2	Module Firmware Version	Module Firmware Version.
41-63	23	Reserved Area	Reserved for future standardization
64-82	19	Custom Area	Vendor or module type specific use
83-84	2	Inactive Firmware Version	Version Number of Inactive Firmware. Values of 00h
			indicates module supports only a single image.
85-117	33	Application Advertising	Combinations of host and media interfaces that are
			supported by module data path(s)
118-125	8	Password Entry and Change	
126	1	Bank Select Byte	Bank address of currently visible Page
127	1	Page Select Byte	Page address of currently visible Page

Figure 6. The Lower Memory Overview



The Upper Memory - Page 00h

Upper page 00h contains static read-only module identification information.

Address	Size (bytes)	Name	Description
128	1	Identifier	Identifier Type of module
129-144	16	Vendor name	Vendor name (ASCII)
145-147	3	Vendor OUI	Vendor IEEE company ID
148-163	16	Vendor PN	Part number provided by vendor (ASCII)
164-165	2	Vendor rev	Revision level for part number provided by vendor (ASCII)
166-181	16	Vendor SN	Vendor Serial Number (ASCII)
182-189	8	Date Code	
190-199	10	CLEI code	Common Language Equipment Identification code
200-201	2	Module power	
		characteristics	
202	1	Cable assembly length	
203	1	Media Connector Type	
204-209	6	Copper Cable Attenuation	
210-211	2	Cable Assembly Lane	
		Information	
212	1	Media Interface Technology	
213-220	8	Reserved	
221	1	Custom	
222	1	Checksum	Includes bytes 128-221
223-255	33	Custom Info NV	

Figure 7. Page 00h Memory Overview

The Upper Memory – Page 01h (Advertising)

Upper page 01h contains advertising fields that define properties that are unique to active modules and cable assemblies.

Byte	Size	Name	Description
	(bytes)		
128-131	4	Module Firmware and Hardware revisions	
132-137	6	Supported link length	Supported lengths of various fiber media
138-139	2	Nominal Wavelength	
140-141	2	Wavelength Tolerance	
142-144	3	Implemented Memory Pages and Durations advertising	
145-154	10	Module Characteristics advertising	
155-156	2	Implemented Controls advertising	
157-158	2	Implemented Flags advertising	
159-160	2	Implemented Monitors advertising	
161-162	2	Implemented Signal Integrity Controls advertising	
163-166	4	CDB support advertising	
167-168	2	Additional Durations advertising	
169-175	7	Reserved	
176-190	15	Module Media Lane advertising	
191-222	32	Custom	
223-250	28	Extended Module Host-Media Interface Advertising options	
251-254	4	Reserved	
255	1	Checksum	Checksum of bytes 130-254 ¹

Figure 8. Page 01h Memory Overview



The Upper Memory – Page 02h (Module and Lane Thresholds)

Upper Page 02h contains the module-defined thresholds for module-level and lane-specific monitors. The presence of Page 02h is advertised in bit 7 in Page 00h byte 2.

Byte	Size (bytes)	Name	Description
128-175	48	Module-level monitor thresholds	
176-199	24	Lane-specific monitor thresholds	
200-229	30	Reserved	
230-254	25	Custom	
255	1	Checksum	Covers bytes 128-254

Figure 9. Page 02h Memory Overview

The Upper Memory – Page 10h (Lane and Data Path Control)

The upper memory map page 10h is a banked page that contains lane dynamic control bytes. The presence of Page 10h is advertised in bit 7 in Page 00h byte 2.

Byte	Size (bytes)	Name	Description
128	1	DataPathDeinit	Data Pathcontrol bits for each lane, controls Data Path State machine
129-142	14	Lane-Specific Control	Fields to control lane attributes independent of the Data Path State machine or control sets
143-177	35	Staged Control Set 0	Fields to configure the selected Application Code and signal integrity settings
178-212	35	Staged Control Set 1	Fields to configure the selected Application Code and signal integrity settings
213-231	19	Lane-Specific Flag Masks	
232-239	8	Reserved	
240-255	16	Custom	

Figure 10. Page 02h Memory Overview

The Upper Memory – Page 11h (Lane Status)

The upper memory map page 11h is a banked page that contains lane dynamic status bytes. The presence of Page 11h is conditional on the state of bit 7 in Page 00h byte 2. All fields on Page 11h are read-only.

Byte	Size (bytes)	Name	Description
128-131	4	Data Path State indicators	
132-133	2	Reserved	
134-152	19	Lane-specific flags	
153	1	Reserved	
154-201	48	Lane-specific monitors	
202-205	4	Configuration Error Codes	Indicates validity of select Application codes
206-234	29	Active Control Set	
235-239	5	Reserved	
240-255	16	Host Electrical to Module Media Lane Mapping	Indicates the mapping of Host Electrical lanes to Module Media lanes

Figure 11. Page 11h Memory Overview

Mechanical Dimensions

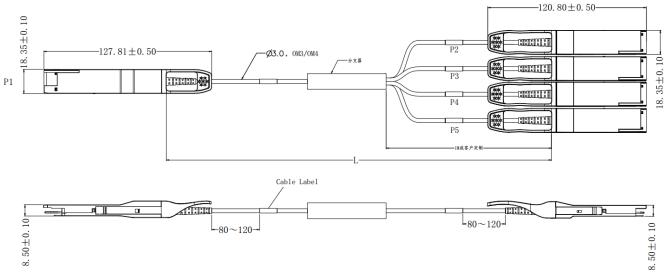


Figure 12. Mechanical Specifications

Wiring Patterns

P1, QSFP56-DD		P2, QSFP56			P1, QSFP56-DD		P4, QSFP56			
GND		GND			GN	ND .		G:	ND	
TX1+	36		17	RX1+		TX5+	74		17	RX1+
TX1-	37		18	RX1-		TX5-	75		18	RX1-
TX2+	3		22	RX2+		TX6+	41		22	RX2+
TX2-	2		21	RX2-		TX6-	40		21	RX2-
RX1+	17		36	TX1+		RX5+	55		36	TX1+
RX1-	18		37	TX1-		RX5-	56		37	TX1-
RX2+	22		3	TX2+		RX6+	60		3	TX2+
RX2-	21		2	TX2-		RX6-	59		2	TX2-
GND		GND			GND			GND		
P1, QSI	FP56-DD		P3, G	SFP56		P1, QSI	PP56-DD		P5, (SFP56
	FP56-DD			QSFP56		P1, QSI				ND
Gì	ND		G]	ND		Gì	VD		G:	ND
GN TX3+	ND 33		Gl 17	ND RX1+		GN TX7+	ND 71		G 17	ND RX1+
TX3+ TX3-	ND 33 34		17 18	ND RX1+ RX1-		TX7+ TX7-	ND 71 72		17 18	ND RX1+ RX1-
TX3+ TX3- TX4+	ND 33 34 6		17 18 22	ND RX1+ RX1- RX2+		GY TX7+ TX7- TX8+	VD 71 72 44		17 18 22	ND RX1+ RX1- RX2+
TX3+ TX3- TX4+ TX4-	33 34 6 5		17 18 22 21	RX1+ RX1- RX2+ RX2-		GY TX7+ TX7- TX8+ TX8-	71 72 44 43		17 18 22 21	RX1+ RX1- RX2+ RX2-
TX3+ TX3- TX4+ TX4- RX3+	33 34 6 5 14		17 18 22 21 36	RX1+ RX1- RX2+ RX2- TX1+		TX7+ TX7- TX8+ TX8- RX7+	71 72 44 43 52		17 18 22 21 36	RX1+ RX1- RX2+ RX2- TX1+
TX3+ TX3- TX4+ TX4- RX3+ RX3-	33 34 6 5 14 15		17 18 22 21 36 37	RX1+ RX1- RX2+ RX2- TX1+ TX1-		TX7+ TX7- TX8+ TX8- RX7+ RX7-	71 72 44 43 52 53		17 18 22 21 36 37	RX1+ RX1- RX2+ RX2- TX1+ TX1-

Figure 13. Wiring Patterns

Optical Interconnection Design Innovator

Regulatory Compliance

Gigalight GDA4-MDO401-XXXCA 400GbE to 4x100GbE AOC transceiver is Class 1 Laser Products.

They are certified per the following standards:

Feature	Agency	Standard
Laser Eye Safety	FDA/CDRH	CDRH 21 CFR 1040 and Laser Notice 50
EMC	FCC	47 CFR FCC Part 15 Subpart B
EMC	CE-EMC	EN 55032:2015 EN 55024:2010+A1:2015 EN 61000-3-2:2014 EN 61000-3-3:2013

Complies with FDA performance standards for laser products except for deviations pursuant to Laser Notice No. 50, dated June 24, 2007.

References

- 1. QSFP DD MAS Rev3.0
- 2. IEEE802.3cd 400GBASE-SR8.
- 3. IEEE802.3cd 100GBASE-SR2.
- 4. CMIS V4.0 Management Interface.
- 5. OIF CEI-56G-VSR-PAM4.

ACAUTION:

Use of controls or adjustment or performance of procedures other than those specified herein may result in hazardous radiation exposure.

Ordering Information

Part Number	Product Description
GDA4-MDO401-XXXCA	QSFP56-DD, 400GbE to 4x100GbE MMF Active Optical Splitter Cable.
XXX	005-5m, 020-20m, 050-50m, 100-100m

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by Gigalight before they become applicable to any particular order or contract. In accordance with the Gigalight policy of continuous improvement specifications may change without notice.



Optical Interconnection Design Innovator

The publication of information in this data sheet does not imply freedom from patent or other protective rights of Gigalight or others. Further details are available from any Gigalight sales representative.

E-mail: sales@gigalight.com
Official Site: www.gigalight.com

Revision History

Revision	Date	Description
V0	June-17-2020	Advance Release.